

STTH208-Y

Datasheet

Automotive high voltage ultrafast rectifier



Features

- AEC-Q101 qualified
- Very low conduction losses
- Negligible switching losses
- Low forward and reverse recovery times
- High junction temperature
- ECOPACK2 or ECOPACK3 compliant component on demand

Description

The STTH208-Y, which is using ST's new 1000 V planar technology, is especially suited for switching mode base drive and transistor circuits.

The device is also intended for use as a free-wheeling diode in power supplies and other power switching applications in automotive K functions.



Product status link				
STTH208-Y				
Product summary				
I _{F(AV)}	2 A			
V _{RRM}	800 V			
T _j (max.)	175 °C			
V _F (typ.)	0.89 V			
T _{rr} (typ.)	53 ns			

1 Characteristics

Table 1. Absolute ratings (limiting values at T_j= 25 °C, unless otherwise specified)

Symbol	Para	Parameter		Unit
V _{RRM}	Repetitive peak reverse	Repetitive peak reverse voltage		V
I _{F(AV)}	Average forward current	T _L =120 °C δ = 0.5	2	А
I _{FSM}	Forward surge current	t _p = 8.3 ms	30	А
T _{stg}	Storage temperature ran	Storage temperature range		°C
Tj ⁽¹⁾	Operating temperature r	Operating temperature range		°C

1. $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-I)}	Junction to lead	18	°C/W

Table 3. Static electrical characteristic

	Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
			T _j = 25 °C	V _R =V _{RRM}	-		5	μA
	I _R ⁽¹⁾ Reverse leakage current	T _j = 125 °C	-		1	50		
	V _F ⁽²⁾ Forward voltage drop		T _j = 25 °C	I _F =2 A	-		1.55	V
			T _j = 150 °C	'F- ∠ ∧	-	0.89	1.25	

1. Pulsetest: tp = 5 ms, $\delta < 2\%$

2. Pulsetest: tp = 380 μ s, δ < 2%

To evaluate the conduction losses use the following equation:

 $P = 1.05 \text{ x } I_{F(AV)} + 0.10 I_{F^2(RMS)}$

Table 4. Dynamic electrical characteristics

Symbol	Parameter	Test conditions			Тур.	Max.	Unit
t _{rr}	Reverse recovery time	T _j = 25 °C	I _F =0.5 A; I _{rr} =0.25 A; I _R =1 A	-	53	75	20
t _{fr}	Forward recovery time	Ti= 25 °C	I _F =2 A; dI _{F/dt} = 50 A/μs; V _{FR} =1.9 V	-		200	ns
V _{FP}	Forward recovery voltage	1j- 20 0		-	6	9	V

1.1 Electrical characteristics (curves)



















2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 SMB Flat package information

- Epoxy meets UL94, V0
- Lead-free package



Figure 7. SMB Flat package outline

Table 5. SMB Flat mechanical data

			Di	mensions			
Ref.		Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	0.90		1.10	0.035		0.043	
b	1.95		2.20	0.077		0.087	
С	0.15		0.40	0.006		0.016	
D	3.30		3.95	0.130		0.156	
E	5.10		5.60	0.200		0.220	
E1	4.05		4.60	0.159		0.181	
L	0.75		1.50	0.030		0.060	
L2		0.60			0.024		



Figure 8. Footprint recommendations, dimensions in mm (inches)

millimeters (inches)





3 Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STTH208UFY	F208Y	SMBflat	50mg	5000	Tape and reel

Revision history

Date	Version	Changes
04-Feb-2014	1	Initial release.
01-Mar-2022	2	Updated Section 2.1 SMB Flat package information.

Table 6. Document revision history

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